

TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

# TCR3UG series

Ultra low quiescent current, Fast Load Transient 300 mA CMOS Low Dropout Regulator in ultra small package

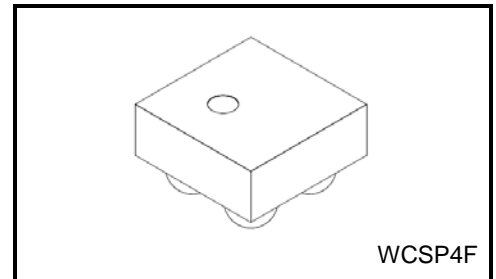
## 1. Description

The TCR3UG series are CMOS general-purpose single-output voltage regulators with an on/off control input, featuring ultra low quiescent bias current and low dropout voltage.

These voltage regulators are available in fixed output voltages between 0.8 V and 5.0 V and capable of driving up to 300 mA. They feature Over-current protection, Thermal Shutdown function and Auto-discharge option.

The TCR3UG series is offered in the ultra small plastic mold package WCSP4F (0.645 mm x 0.645 mm (typ.); t 0.33 mm (max)) and has a low dropout voltage of 155 mV (3.3 V output, I<sub>OUT</sub> = 300 mA). As small ceramic input and output capacitors 1 μF can be used with the TCR3UG series, these devices are ideal for portable applications that require high-density board assembly

such as cellular phones, IoT equipment and wearable devices.



WCSP4F

Weight: 0.26 mg (typ.)

## 2. Applications

Power IC developed for portable applications, IoT equipment and wearable devices

## 3. Features

- Ultra small package WCSP4F (0.645 mm x 0.645 mm (typ.); t 0.33 mm (max)).
- Low quiescent bias current (I<sub>B(ON)</sub> = 0.34 μA (typ.) at I<sub>OUT</sub> = 0 mA, output voltage up to 1.5 V)
- High ripple rejection ratio 70 dB at 0.8 V-output
- Fast load transient response ± 60 mV at 0.8 V-output, I<sub>OUT</sub> = 1 mA ↔ 50 mA
- Low dropout voltage  
V<sub>DO</sub> = V<sub>IN</sub> - V<sub>OUT</sub> = 140 mV (typ.) at 3.3 V-output, I<sub>OUT</sub> = 300 mA
- Wide range output voltage line up (V<sub>OUT</sub> = 0.8 to 5.0 V)
- High V<sub>OUT</sub> accuracy ± 1.0 % (1.8 V ≤ V<sub>OUT</sub>)
- Auto-discharge (TCR3UGxxA series)/ Non-discharge (TCR3UGxxB series) line up
- Overcurrent protection
- Thermal shutdown function
- Inrush current protection circuit
- Pull down connection between CONTROL and GND
- Ceramic capacitors can be used (C<sub>IN</sub> = 1 μF, C<sub>OUT</sub> = 1 μF)

Start of commercial production  
2017-10

### 4. Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Input voltage	V <sub>IN</sub>	-0.3 to 6.0	V
Control voltage	V <sub>CT</sub>	-0.3 to V <sub>IN</sub> + 0.3 ≤ 6.0	V
Output voltage	V <sub>OUT</sub>	-0.3 to V <sub>IN</sub> + 0.3 ≤ 6.0	V
Power dissipation	P <sub>D</sub>	800 (Note1)	mW
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature range	T <sub>stg</sub>	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note1: Rating at mounting on a board

Glass epoxy (FR4) board dimension: 40 mm x 40 mm (both sides of board), t = 1.6 mm

Metal pattern ratio: a surface approximately 50 %, the reverse side approximately 50 %

Through hole : diameter 0.5 mm x 24

### 5. Operating Ranges

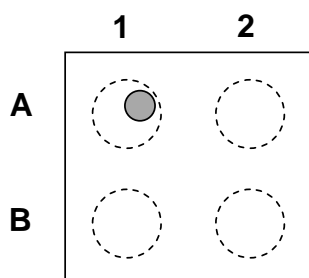
Characteristics	Symbol	Rating	Unit
Input voltage	V <sub>IN</sub>	1.5 to 5.5 (Note 2)	V
Control voltage	V <sub>CT</sub>	0 to V <sub>IN</sub>	V
Output voltage	V <sub>OUT</sub>	0.8 to 5.0	V
Output current	I <sub>OUT</sub>	DC 300 (Note 3)	mA
Operating Temperature	T <sub>opr</sub>	-40 to 85	°C
Output Capacitance	C <sub>OUT</sub>	≥ 1.0 μF	—
Input Capacitance	C <sub>IN</sub>	≥ 1.0 μF	—

Note 2: I<sub>OUT</sub> = 1 mA.

Please refer to Dropout Voltage (Page 13) and use it within Absolute Maximum Ratings Junction temperature and Operating Temperature Ranges.

Note 3: Do not operate at or near the maximum ratings of operating ranges for extended periods of time. Exposure to such conditions may adversely impact product reliability and results in failures not covered by warranty.

### 6. Pin Assignment (top view)



	1	2
A	V <sub>IN</sub>	V <sub>OUT</sub>
B	CONTROL	GND

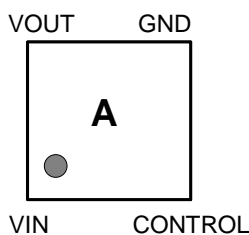
### 7. List of Products Number, Output voltage and Marking

Product No.	Output voltage(V)	Auto dis-charge	Marking	Product No.	Output voltage(V)	Auto dis-charge	Marking**
TCR3UG08A	0.8	Yes	A	TCR3UG08B	0.8	No	A
TCR3UG085A	0.85		B	TCR3UG085B	0.85		B
TCR3UG09A	0.9		C	TCR3UG09B	0.9		C
TCR3UG095A	0.95		D	TCR3UG095B	0.95		D
TCR3UG10A	1.0		E	TCR3UG10B	1.0		E
TCR3UG105A	1.05		F	TCR3UG105B	1.05		F
TCR3UG11A	1.1		H	TCR3UG11B	1.1		H
TCR3UG115A	1.15		J	TCR3UG115B	1.15		J
TCR3UG12A	1.2		K	TCR3UG12B	1.2		K
TCR3UG13A	1.3		L	TCR3UG13B	1.3		L
TCR3UG135A	1.35		M	TCR3UG135B	1.35		M
TCR3UG15A	1.5		N	TCR3UG15B	1.5		N
TCR3UG175A	1.75		P	TCR3UG175B	1.75		P
TCR3UG18A	1.8		R	TCR3UG18B	1.8		R
TCR3UG1825A	1.825		G	TCR3UG185B	1.85		S
TCR3UG185A	1.85		S	TCR3UG19B	1.9		T
TCR3UG19A	1.9		T	TCR3UG25B	2.5		U
TCR3UG25A	2.5		U	TCR3UG26B	2.6		V
TCR3UG26A	2.6		V	TCR3UG27B	2.7		W
TCR3UG27A	2.7		W	TCR3UG28B	2.8		X
TCR3UG28A	2.8		X	TCR3UG285B	2.85		Y
TCR3UG285A	2.85		Y	TCR3UG30B	3.0		0
TCR3UG30A	3.0		0	TCR3UG31B	3.1		1
TCR3UG31A	3.1		1	TCR3UG32B	3.2		2
TCR3UG32A	3.2		2	TCR3UG33B	3.3		3
TCR3UG33A	3.3		3	TCR3UG35B	3.5		4
TCR3UG35A	3.5		4	TCR3UG36B	3.6		5
TCR3UG36A	3.6		5	TCR3UG41B	4.1		9
TCR3UG41A	4.1		9	TCR3UG42B	4.2		6
TCR3UG42A	4.2		6	TCR3UG45B	4.5		7
TCR3UG45A	4.5		7	TCR3UG50B	5.0		8
TCR3UG50A	5.0		8				

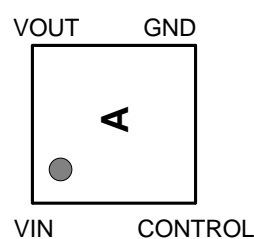
\*\*Marking is rotated 90 degrees to the left.

#### Top Marking (top view)

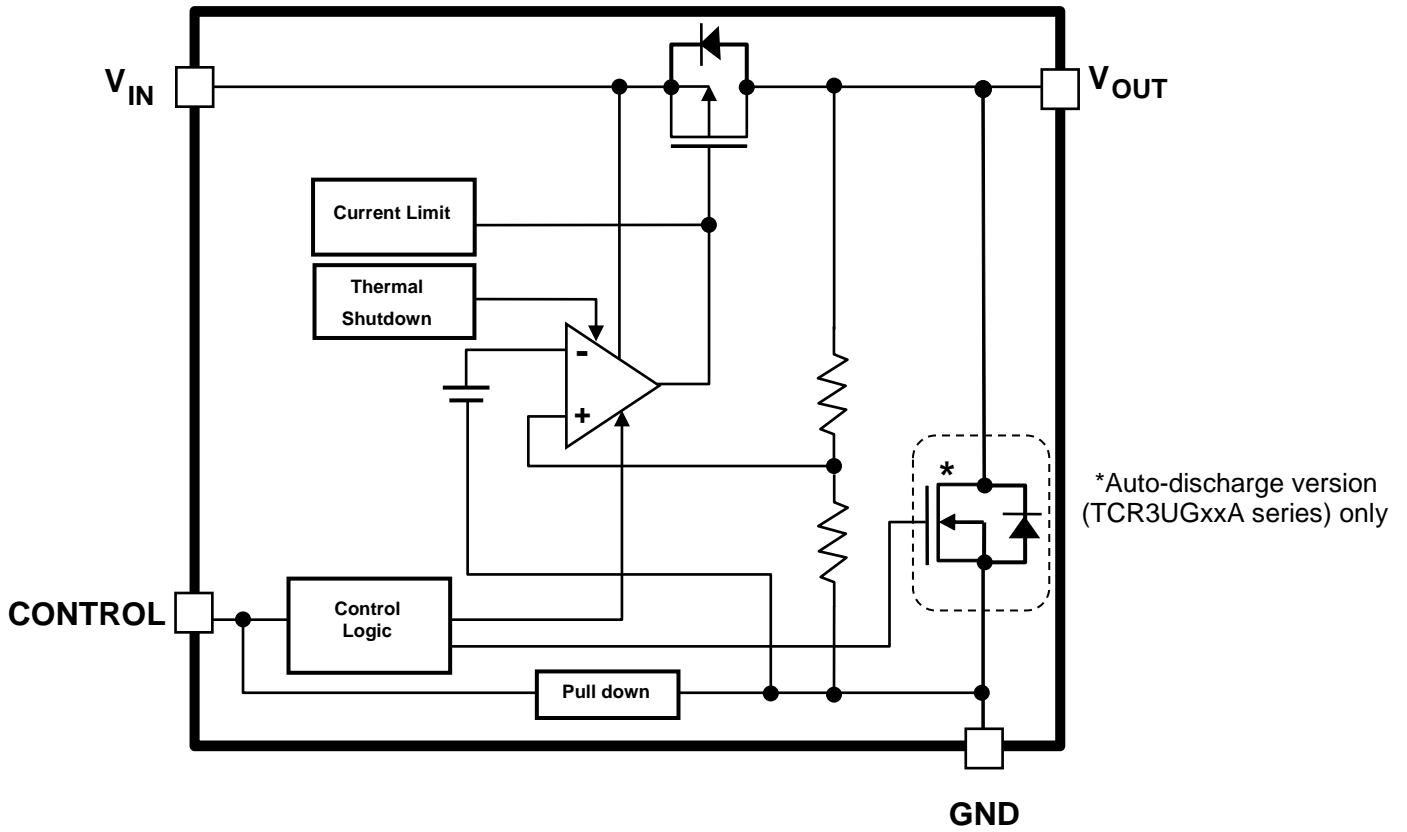
Example: TCR3UG08A (0.8 V output)



Example: TCR3UG08B (0.8 V output)



### 8. Block Diagram



### 9. Electrical Characteristics

(Unless otherwise specified,

$V_{IN} = V_{OUT} + 1 \text{ V}$  ( $V_{OUT} > 1.5 \text{ V}$ ),  $V_{IN} = 2.5 \text{ V}$  ( $V_{OUT} \leq 1.5 \text{ V}$ ),  $I_{OUT} = 50 \text{ mA}$ ,  $C_{IN} = C_{OUT} = 1 \mu\text{F}$ )

Characteristics	Symbol	Test Condition	$T_j = 25^\circ\text{C}$			$T_j = -40 \text{ to } 85^\circ\text{C}$ (Note 9)		Unit	
			Min	Typ.	Max	Min	Max		
Output voltage accuracy	$V_{OUT}$	$I_{OUT} = 50 \text{ mA}$ (Note 4)	$V_{OUT} < 1.8 \text{ V}$	-18	—	+18	—	—	mV
			$1.8 \text{ V} \leq V_{OUT}$	-1.0	—	+1.0	—	—	%
Input voltage	$V_{IN}$	$I_{OUT} = 1 \text{ mA}$	1.5	—	5.5	1.5	5.5	V	
Line regulation	Reg·line	$I_{OUT} = 1 \text{ mA}$ (Note 5)	—	1	15	—	—	mV	
Load regulation	Reg·load	$1 \text{ mA} \leq I_{OUT} \leq 300 \text{ mA}$ (Note 6)	—	10	30	—	—	mV	
Quiescent current	$I_B(\text{ON1})$	$I_{OUT} = 0 \text{ mA}$ , $V_{OUT} \leq 1.5 \text{ V}$ (Note 7)	—	0.34	—	—	0.58	$\mu\text{A}$	
	$I_B(\text{ON2})$	$I_{OUT} = 0 \text{ mA}$ , $1.75 \text{ V} \leq V_{OUT} \leq 5 \text{ V}$ (Note 7)	—	0.38	—	—	0.68	$\mu\text{A}$	
Stand-by current	$I_B(\text{OFF1})$	$V_{CT} = 0 \text{ V}$ , $V_{IN} = 2.5 \text{ V}$	—	0.03	—	—	0.16	$\mu\text{A}$	
	$I_B(\text{OFF2})$	$V_{CT} = 0 \text{ V}$ , $V_{IN} = 5.5 \text{ V}$	—	0.03	—	—	0.20	$\mu\text{A}$	
Control pull down current	$I_{CT}$	—	—	0.1	—	—	—	$\mu\text{A}$	
Dropout voltage	$V_{DO}$	$I_{OUT} = 300 \text{ mA}$	$V_{OUT} = 1.8 \text{ V}$	—	335	—	—	457	mV
			$V_{OUT} = 3.3 \text{ V}$	—	140	—	—	273	mV
Output noise voltage	$V_{NO}$	$I_{OUT} = 10 \text{ mA}$ , $10 \text{ Hz} \leq f \leq 100 \text{ kHz}$ , $T_a = 25^\circ\text{C}$ (Note 6)	—	50	—	—	—	$\mu\text{V}_{\text{rms}}$	
Ripple rejection ratio	R.R.	$I_{OUT} = 10 \text{ mA}$ , $f = 1 \text{ kHz}$ , $V_{\text{Ripple}} = 200 \text{ mV}_{\text{p-p}}$ , $T_a = 25^\circ\text{C}$ (Note 6)	—	70	—	—	—	dB	
Load transient response	$\Delta V_{OUT}$	$I_{OUT} = 1 \text{ mA} \rightarrow 50 \text{ mA}$ (Note 8)	—	-60	—	—	—	mV	
		$I_{OUT} = 50 \text{ mA} \rightarrow 1 \text{ mA}$ (Note 8)	—	+60	—	—	—	mV	
Temperature coefficient	$T_{CVO}$	$-40^\circ\text{C} \leq T_{\text{opr}} \leq 85^\circ\text{C}$	—	75	—	—	—	ppm/ $^\circ\text{C}$	
Control voltage (ON)	$V_{CT}(\text{ON})$	—	1.0	—	5.5	1.0	5.5	V	
Control voltage (OFF)	$V_{CT}(\text{OFF})$	—	0	—	0.4	0	0.4	V	
Discharge on resistance	$R_{SD}$	—	—	10	—	—	—	$\Omega$	

Note 4: stable state with fixed  $I_{OUT}$  condition

Note 5:  $V_{OUT} \leq 1.5 \text{ V}$ ,  $2.5 \text{ V} \leq V_{IN} \leq 5.5 \text{ V}$

$1.75 \text{ V} \leq V_{OUT} \leq 4.2 \text{ V}$ ,  $V_{OUT} + 1 \text{ V} \leq V_{IN} \leq 5.5 \text{ V}$

$V_{OUT} = 4.5 \text{ V}$ ,  $V_{OUT} = 5.0 \text{ V}$ , not applicable

Note 6:  $V_{OUT} = 0.8 \text{ V}$

Note 7: except Control pull down current ( $I_{CT}$ )

Note 8:  $V_{OUT} = 0.8 \text{ V}$ ,  $V_{IN} = 3.3 \text{ V}$

Note 9: This parameter is warranted by design

### 10. Dropout voltage

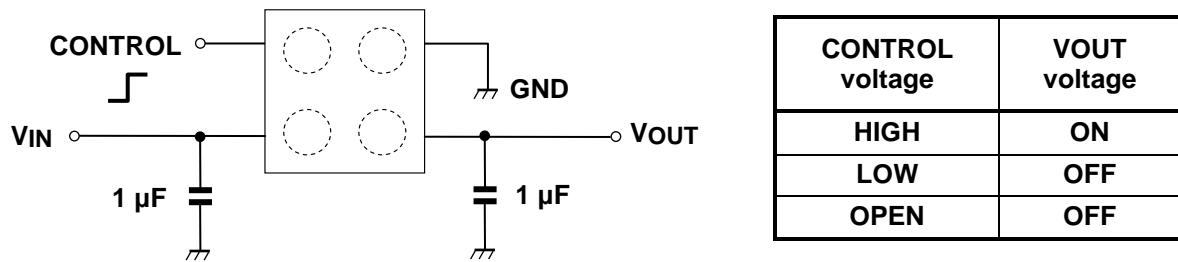
( $I_{OUT} = 300 \text{ mA}$ ,  $C_{IN} = C_{OUT} = 1 \mu\text{F}$ )

Output voltages	Symbol	Min	Typ. $T_j = 25^\circ\text{C}$	Max (Note 10)	Unit
$0.8 \text{ V} \leq V_{OUT} < 0.9 \text{ V}$	V <sub>DO</sub>	—	1025	1257	mV
$0.9 \text{ V} \leq V_{OUT} < 1.0 \text{ V}$		—	930	1157	
$1.0 \text{ V} \leq V_{OUT} < 1.1 \text{ V}$		—	835	1057	
$1.1 \text{ V} \leq V_{OUT} < 1.2 \text{ V}$		—	740	957	
$1.2 \text{ V} \leq V_{OUT} < 1.3 \text{ V}$		—	660	857	
$1.3 \text{ V} \leq V_{OUT} < 1.5 \text{ V}$		—	580	757	
$1.5 \text{ V} \leq V_{OUT} < 1.6 \text{ V}$		—	450	617	
$1.6 \text{ V} \leq V_{OUT} < 1.8 \text{ V}$		—	400	537	
$1.8 \text{ V} \leq V_{OUT} < 2.0 \text{ V}$		—	335	457	
$2.0 \text{ V} \leq V_{OUT} < 2.5 \text{ V}$		—	260	405	
$2.5 \text{ V} \leq V_{OUT} < 3.0 \text{ V}$		—	185	327	
$3.0 \text{ V} \leq V_{OUT} < 3.6 \text{ V}$		—	140	273	
$3.6 \text{ V} \leq V_{OUT} < 4.5 \text{ V}$		—	130	228	
$4.5 \text{ V} \leq V_{OUT} \leq 5.0 \text{ V}$		—	120	195	

Note 10:  $T_j = -40$  to  $85^\circ\text{C}$ . This parameter is warranted by design

### 11. Application Note

#### 11.1. Example of Application Circuit



The figure above shows the Example of configuration for using a Low-Dropout regulator. Insert a capacitor at  $V_{OUT}$  and  $V_{IN}$  pins for stable input/output operation. (Ceramic capacitors can be used).

#### 11.2. Power Dissipation

Board-mounted power dissipation ratings are available in the Absolute Maximum Ratings table. Power dissipation is measured on the board condition shown below.

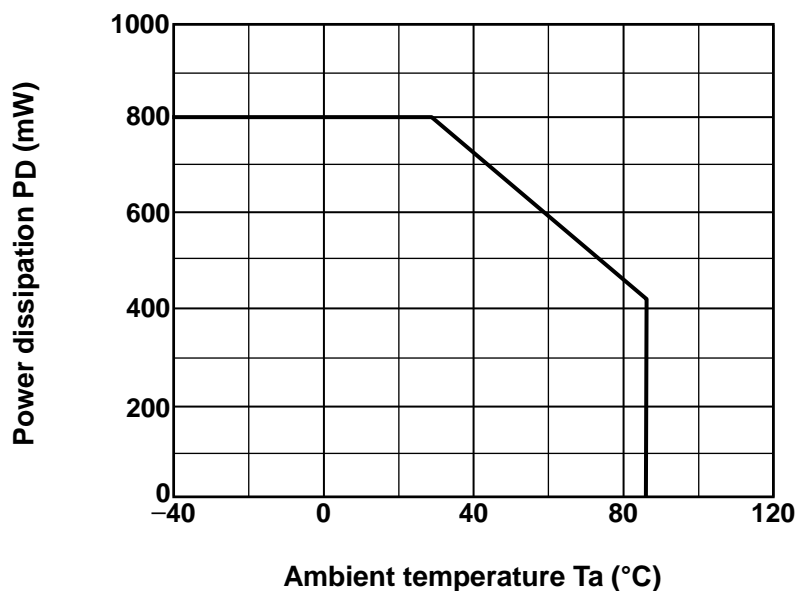
[The Board Condition]

Board material: Glass epoxy (FR4)

Board dimension: 40 mm x 40 mm (both sides of board),  $t = 1.6$  mm

Metal pattern ratio: a surface approximately 50 %, the reverse side approximately 50 %

Through hole: diameter 0.5 mm x 24



### 11.3. Attention in Use

- Output Capacitors

Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommends the ESR of ceramic capacitor is under 10  $\Omega$ . For stable operation, we recommend over 1  $\mu\text{F}$ .

- Mounting

The long distance between IC and input output capacitor might affect phase compensation by impedance in wire and inductor. For stable power supply, input output capacitor need to mount near IC as much as possible. Also VIN and GND pattern need to be large and make the wire impedance small as possible.

- Permissible Loss

Please have enough design patterns for expected maximum permissible loss. And under consideration of ambient temperature, input voltage, output current etc., we recommend proper dissipation ratings for maximum permissible loss; in general maximum dissipation rating is 70 to 80 %.

- Over current Protection and Thermal shutdown function

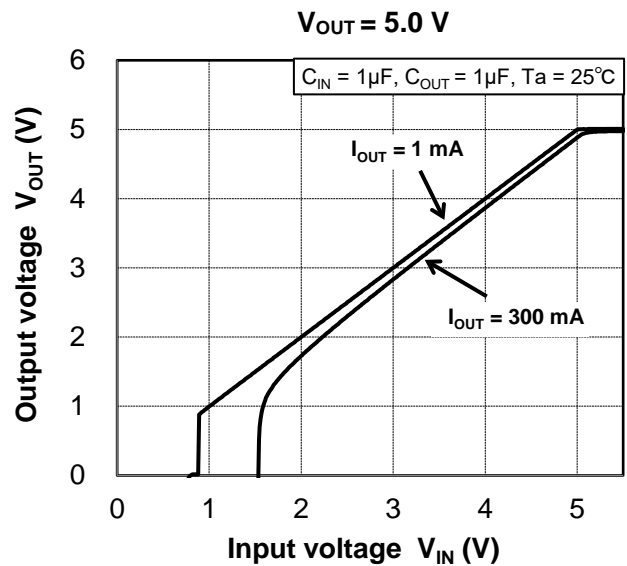
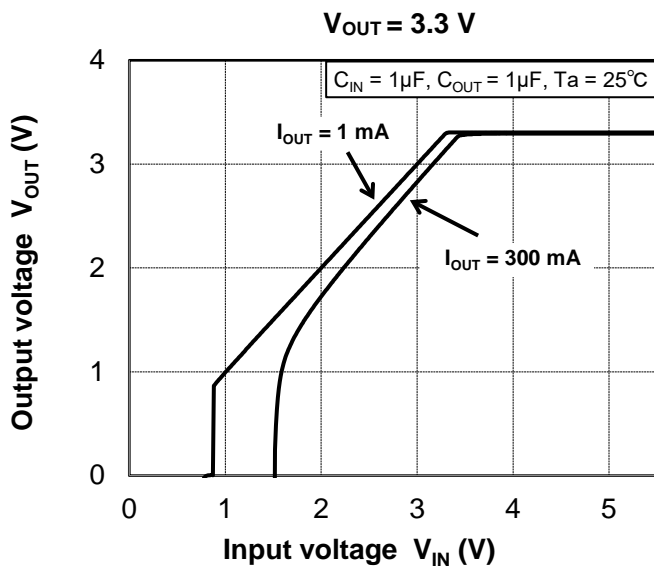
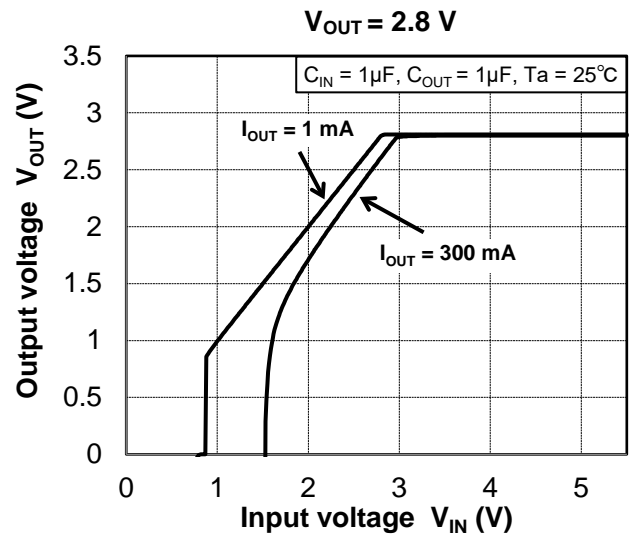
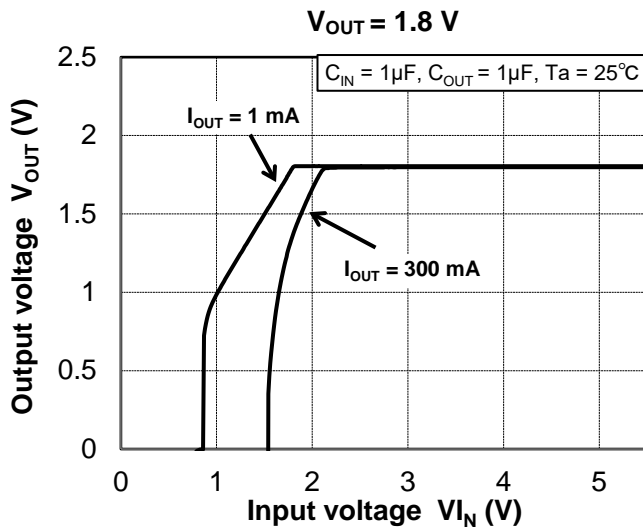
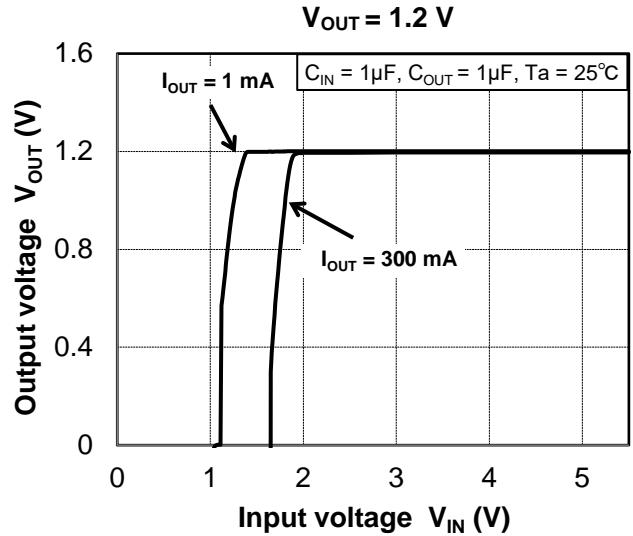
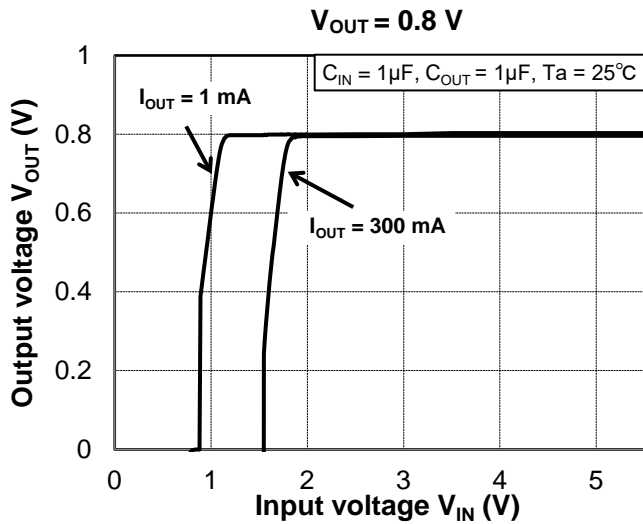
Over current protection and Thermal shutdown function are designed in these products, but these are not designed to constantly ensure the suppression of the device within operation limits. Depending on the condition during actual usage, it could affect the electrical characteristic specification and reliability. Also note that if output pins and GND pins are not completely shorted out, these products might break down.

When using these products, please read through and understand the concept of dissipation for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommends inserting failsafe system into the design.

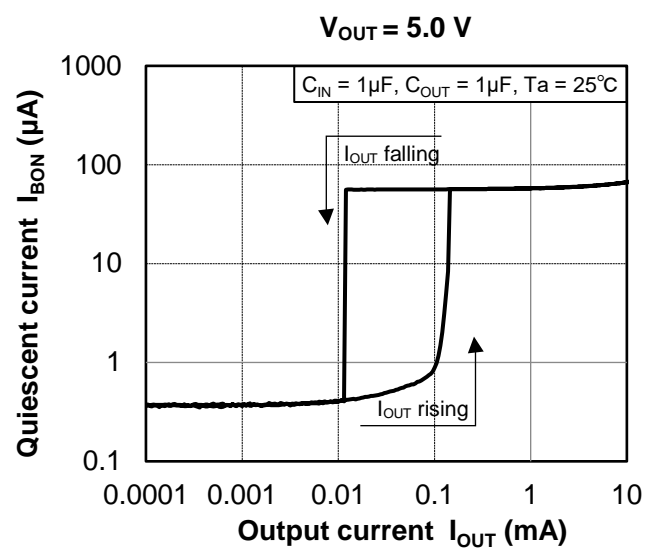
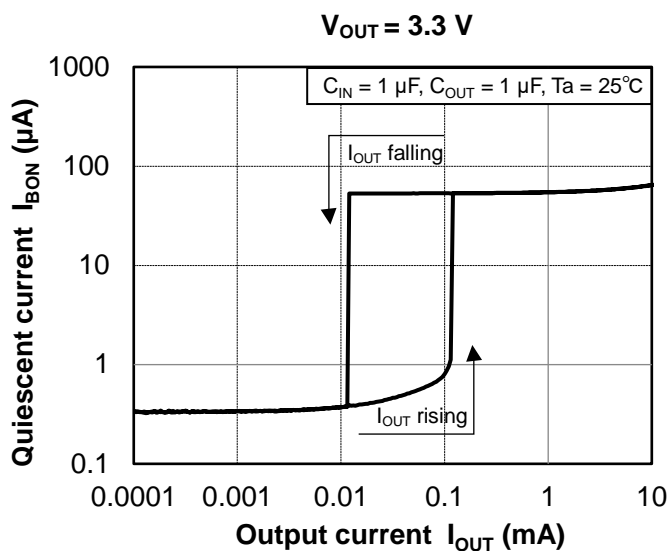
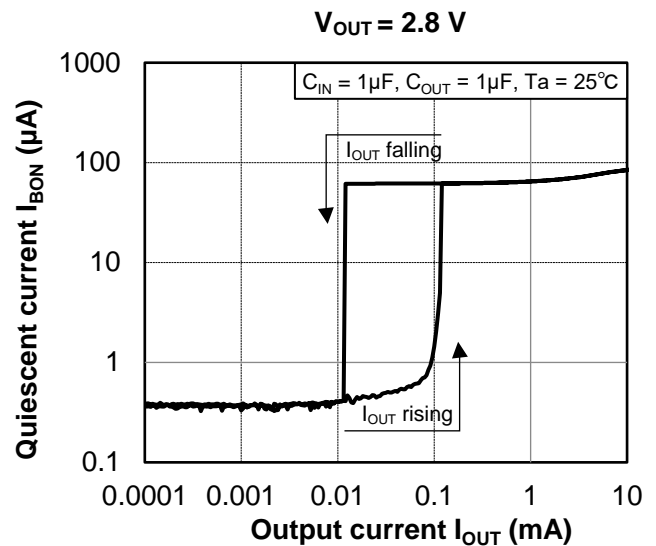
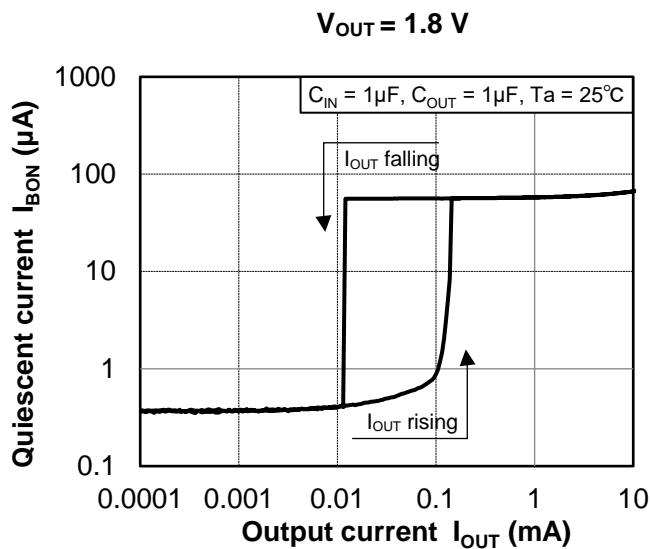
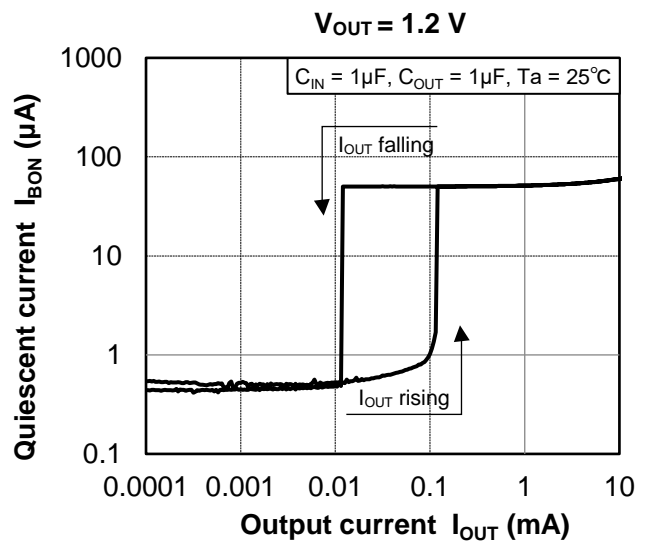
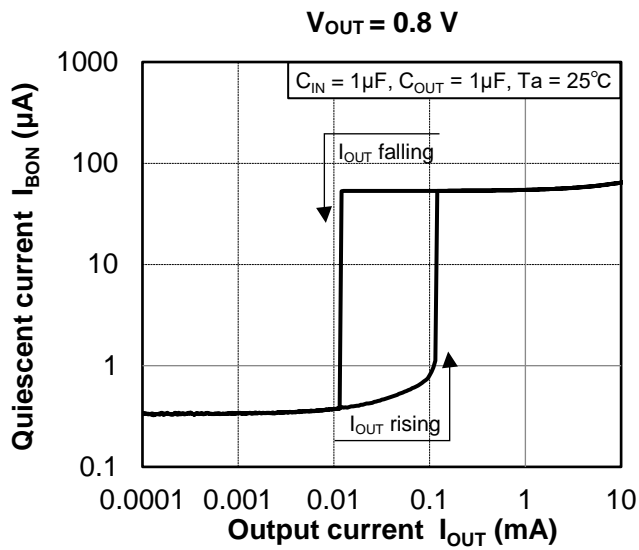


### 12. Representative Typical Characteristics

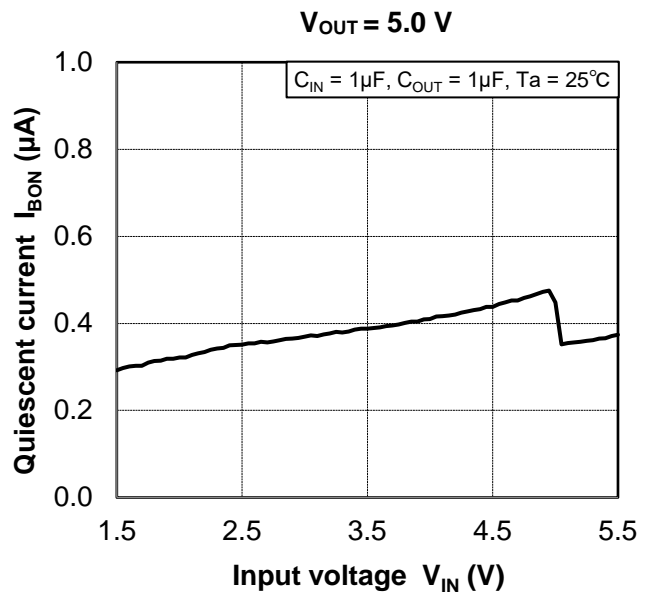
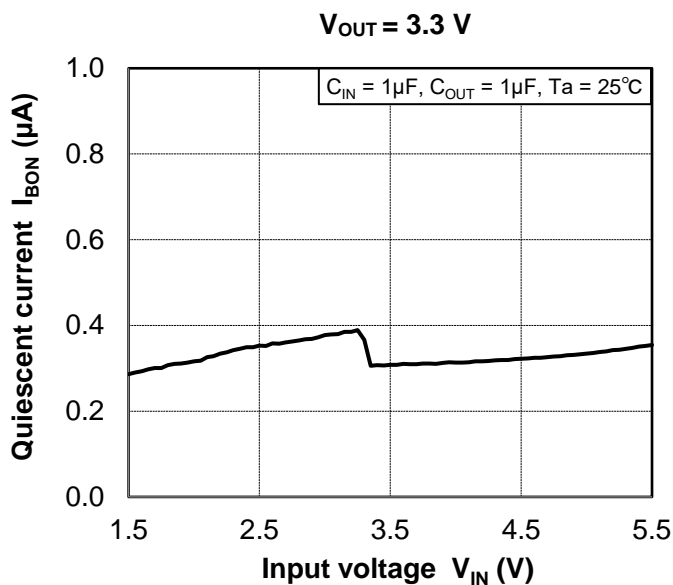
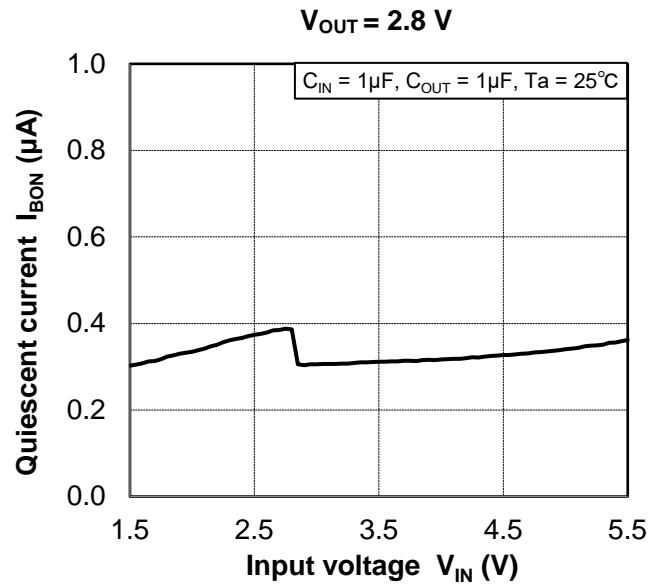
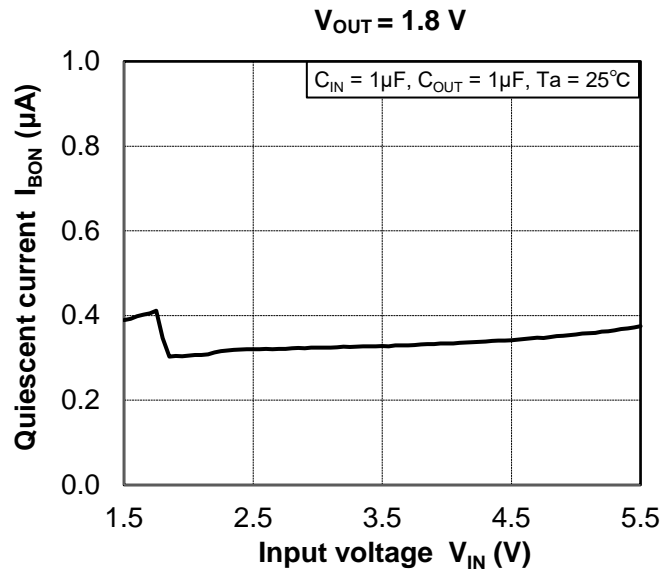
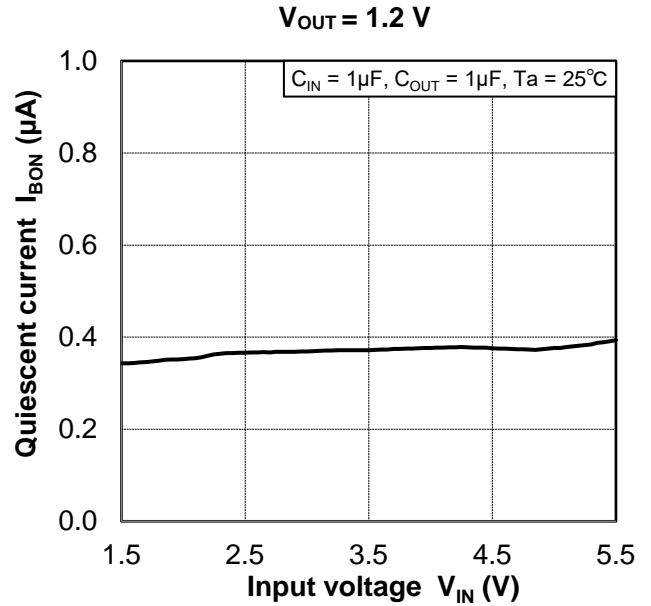
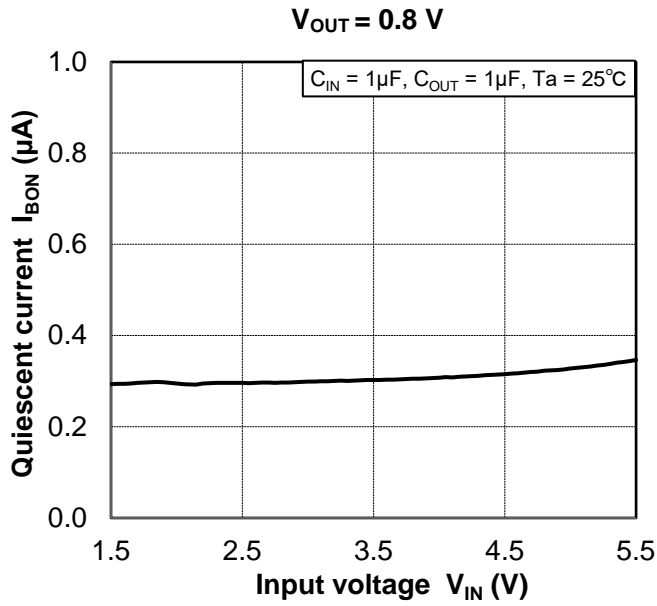
#### 12.1. Output Voltage vs. Input Voltage



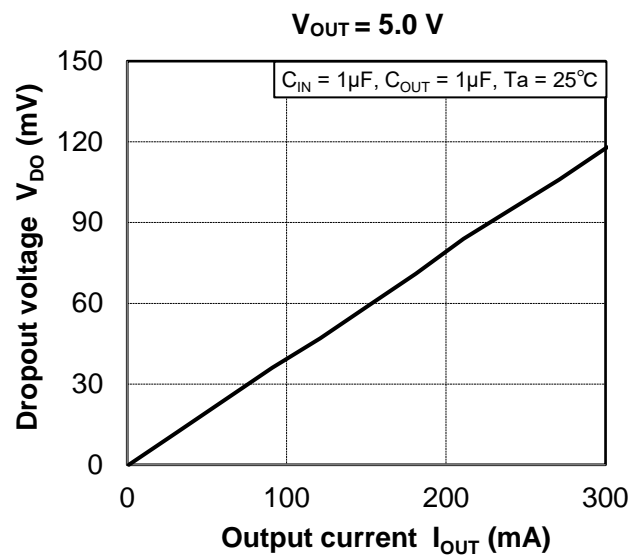
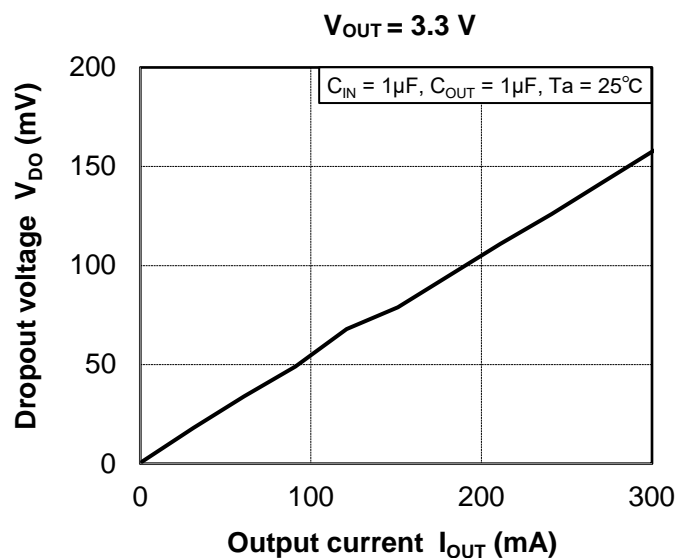
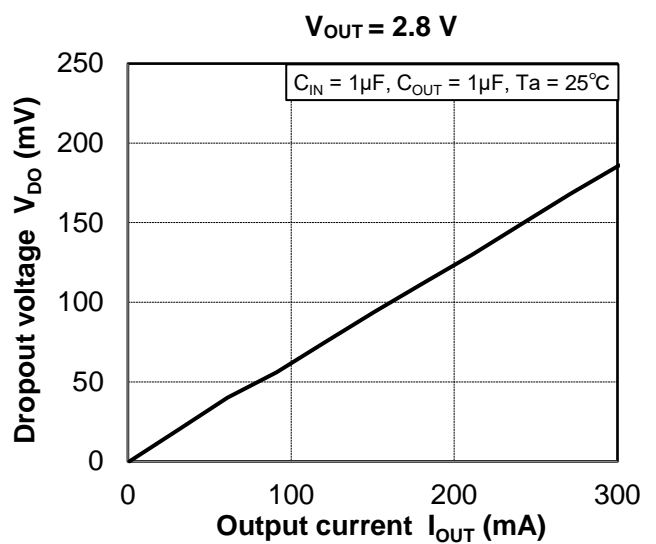
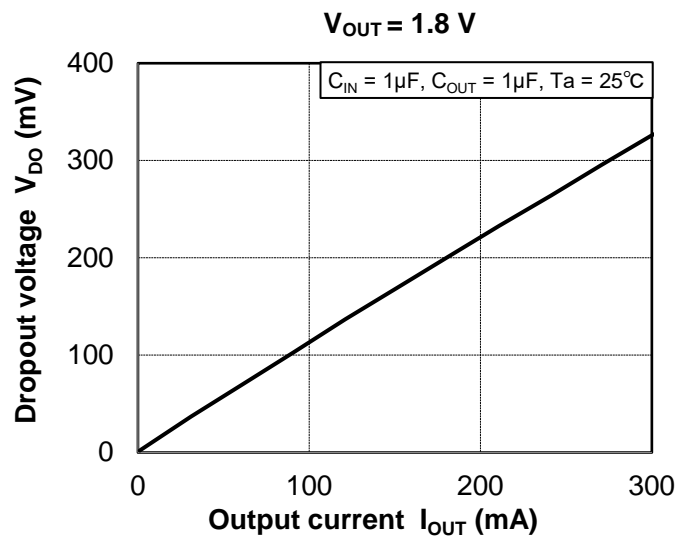
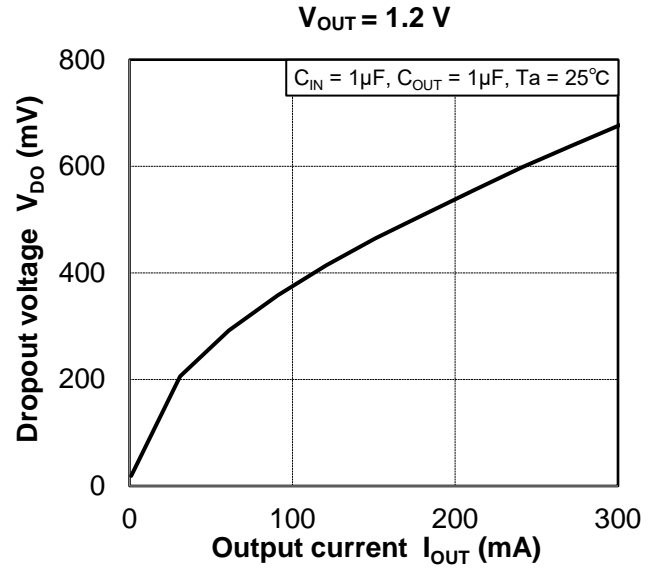
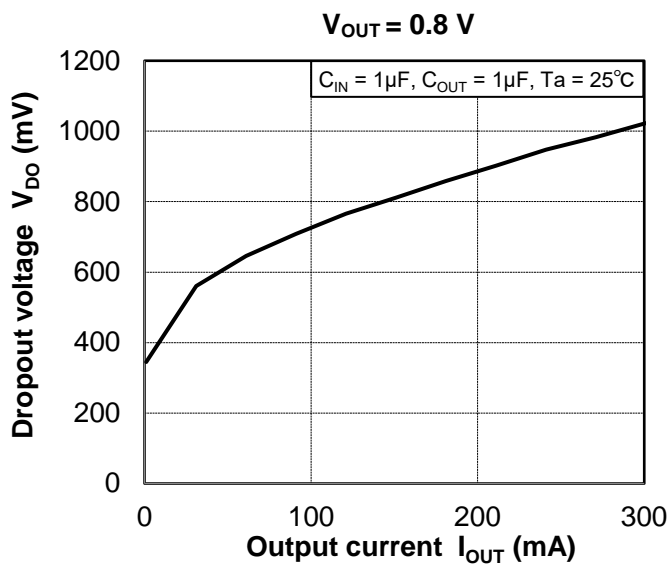
### 12.2. Output Voltage vs. Output Current



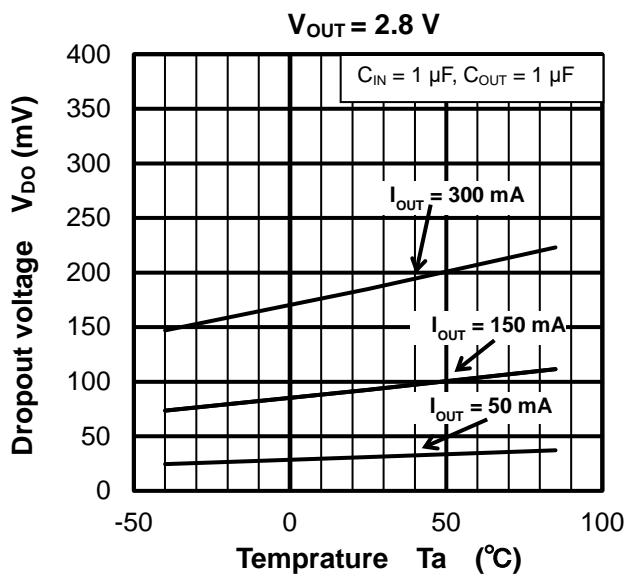
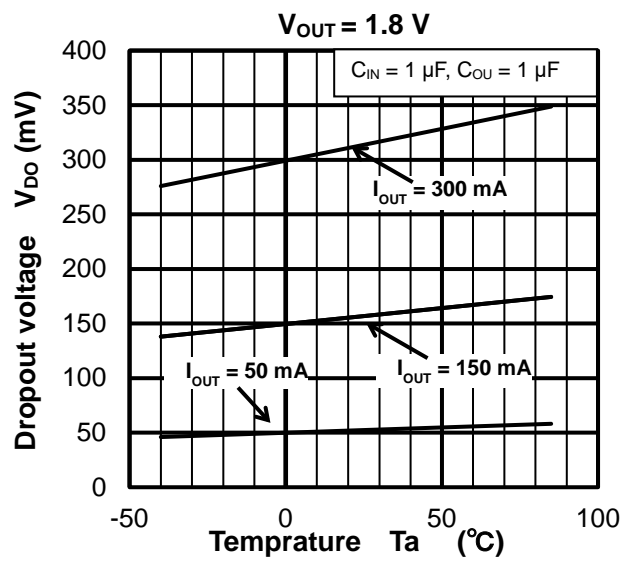
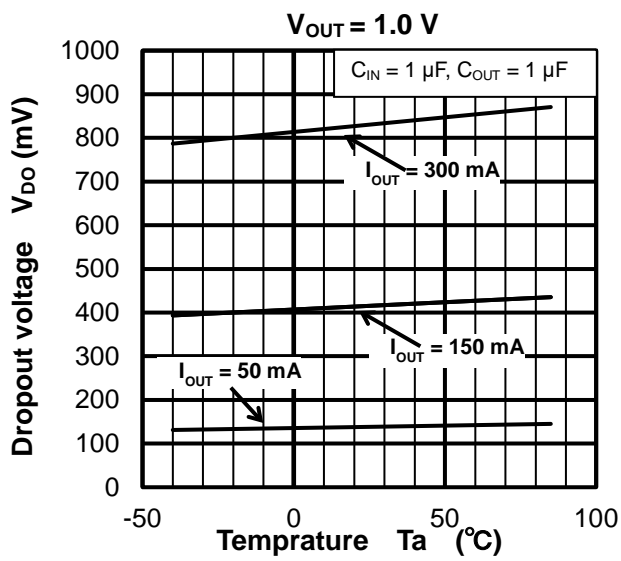
### 12.3. Quiescent Current vs. Input Voltage



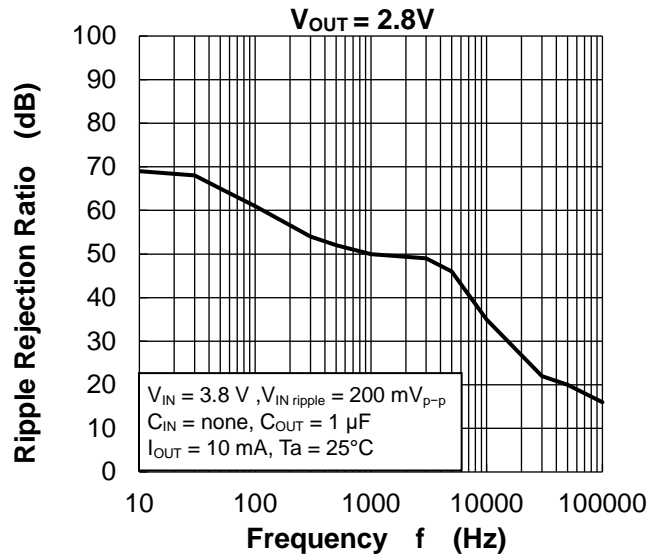
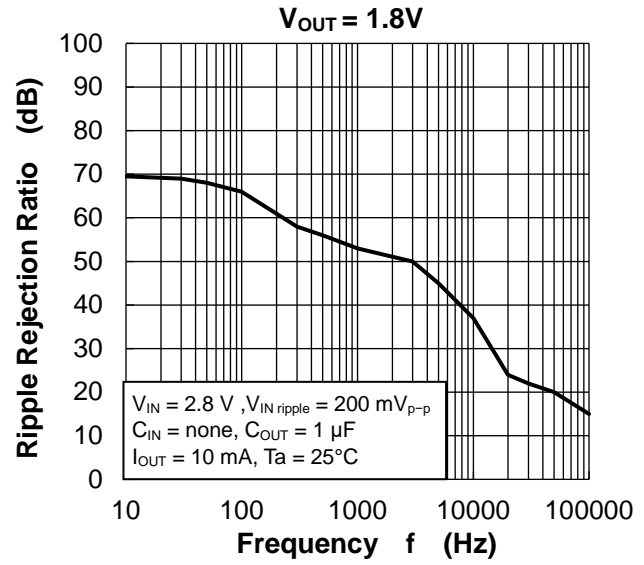
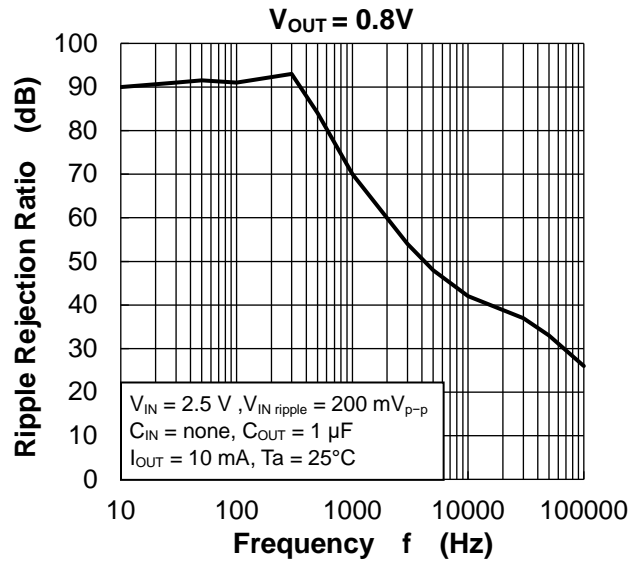
### 12.4. Dropout Voltage vs. Output current



### 12.5. Dropout Voltage vs. Temperature

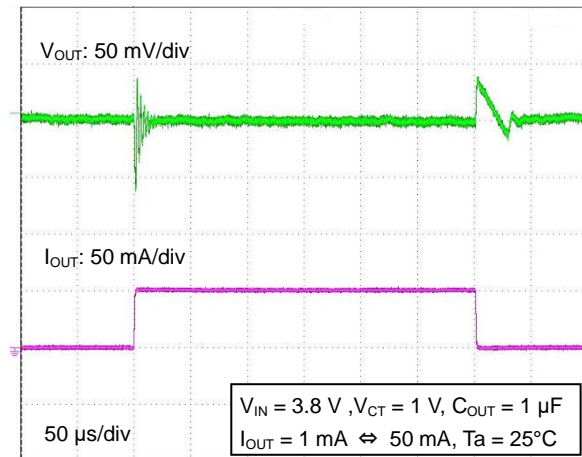


### 12.6. Ripple Rejection Ratio vs. Frequency

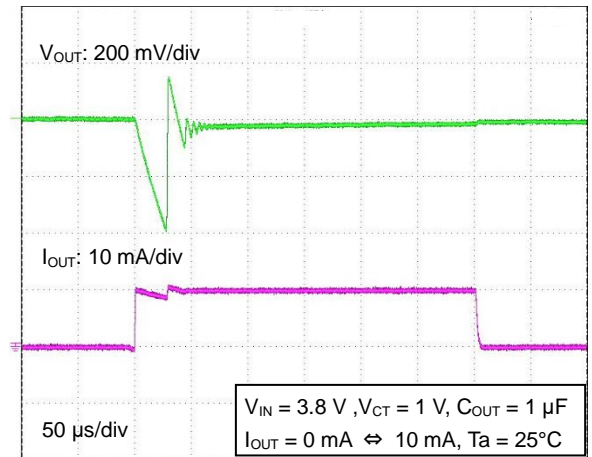


### 12.7. Load Transient Response

$V_{OUT} = 2.8V$

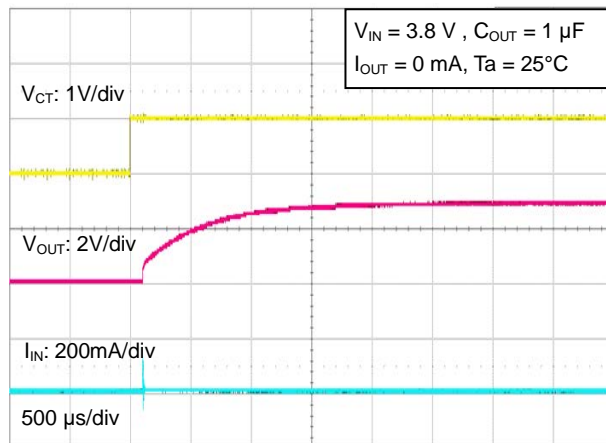


$V_{OUT} = 2.8V$

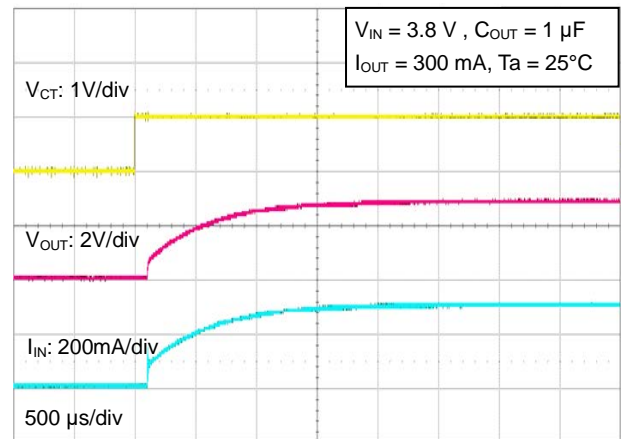


### 12.8. $t_{ON}$ Response

$V_{OUT} = 2.8V$

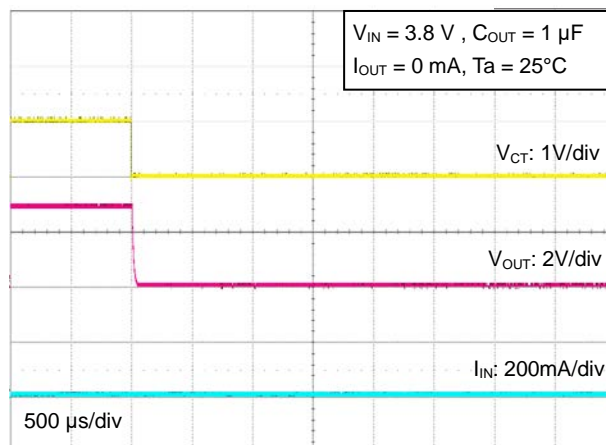


$V_{OUT} = 2.8V$

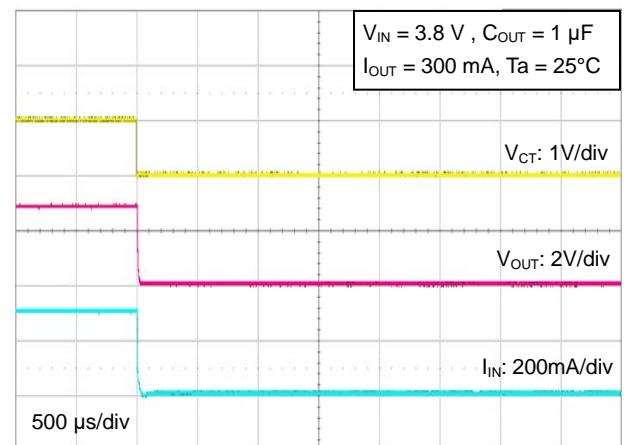


### 12.9. $t_{OFF}$ Response (Auto-discharge)

$V_{OUT} = 2.8V$



$V_{OUT} = 2.8V$

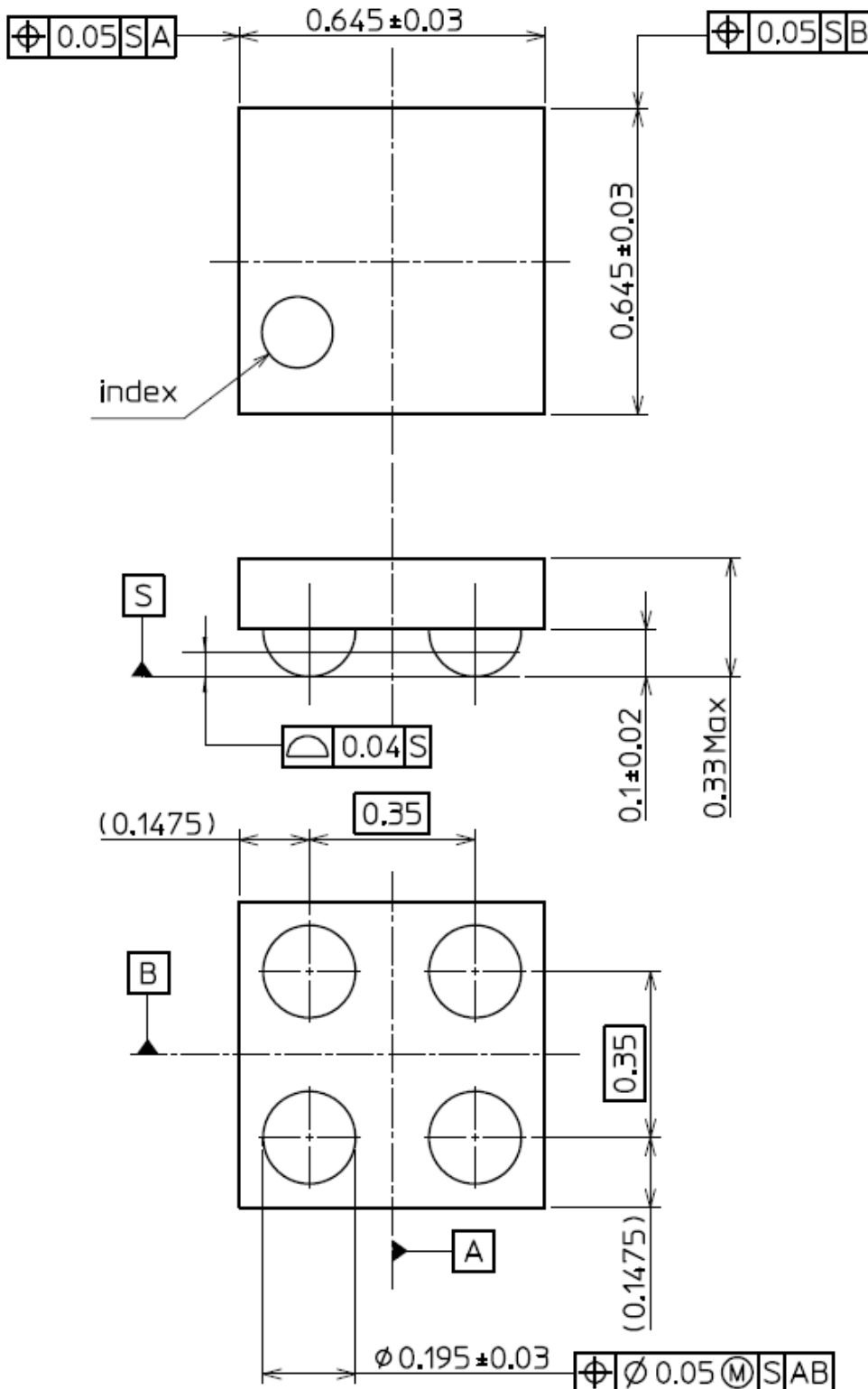


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

### 13. Package Information

WCSP4F

Unit: mm

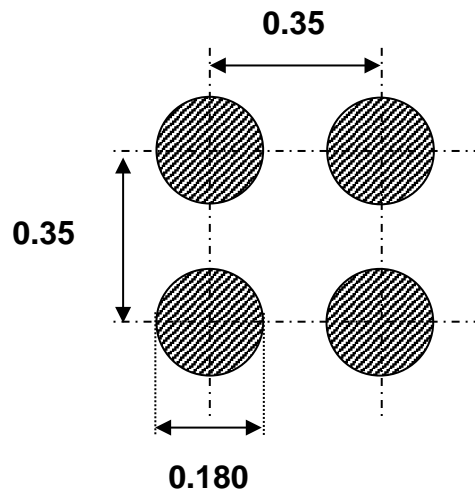


Weight: 0.26 mg (typ.)



Land pattern dimensions for reference only

Unit: mm



## RESTRICTIONS ON PRODUCT USE

Toshiba Corporation and its subsidiaries and affiliates are collectively referred to as "TOSHIBA". Hardware, software and systems described in this document are collectively referred to as "Product".

- TOSHIBA reserves the right to make changes to the information in this document and related Product without notice.
- This document and any information herein may not be reproduced without prior written permission from TOSHIBA. Even with TOSHIBA's written permission, reproduction is permissible only if reproduction is without alteration/omission.
- Though TOSHIBA works continually to improve Product's quality and reliability, Product can malfunction or fail. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for their hardware, software and systems which minimize risk and avoid situations in which a malfunction or failure of Product could cause loss of human life, bodily injury or damage to property, including data loss or corruption. Before customers use the Product, create designs including the Product, or incorporate the Product into their own applications, customers must also refer to and comply with (a) the latest versions of all relevant TOSHIBA information, including without limitation, this document, the specifications, the data sheets and application notes for Product and the precautions and conditions set forth in the "TOSHIBA Semiconductor Reliability Handbook" and (b) the instructions for the application with which the Product will be used with or for. Customers are solely responsible for all aspects of their own product design or applications, including but not limited to (a) determining the appropriateness of the use of this Product in such design or applications; (b) evaluating and determining the applicability of any information contained in this document, or in charts, diagrams, programs, algorithms, sample application circuits, or any other referenced documents; and (c) validating all operating parameters for such designs and applications. **TOSHIBA ASSUMES NO LIABILITY FOR CUSTOMERS' PRODUCT DESIGN OR APPLICATIONS.**
- **PRODUCT IS NEITHER INTENDED NOR WARRANTED FOR USE IN EQUIPMENTS OR SYSTEMS THAT REQUIRE EXTRAORDINARILY HIGH LEVELS OF QUALITY AND/OR RELIABILITY, AND/OR A MALFUNCTION OR FAILURE OF WHICH MAY CAUSE LOSS OF HUMAN LIFE, BODILY INJURY, SERIOUS PROPERTY DAMAGE AND/OR SERIOUS PUBLIC IMPACT ("UNINTENDED USE").** Except for specific applications as expressly stated in this document, Unintended Use includes, without limitation, equipment used in nuclear facilities, equipment used in the aerospace industry, lifesaving and/or life supporting medical equipment, equipment used for automobiles, trains, ships and other transportation, traffic signaling equipment, equipment used to control combustions or explosions, safety devices, elevators and escalators, and devices related to power plant. **IF YOU USE PRODUCT FOR UNINTENDED USE, TOSHIBA ASSUMES NO LIABILITY FOR PRODUCT.** For details, please contact your TOSHIBA sales representative or contact us via our website.
- Do not disassemble, analyze, reverse-engineer, alter, modify, translate or copy Product, whether in whole or in part.
- Product shall not be used for or incorporated into any products or systems whose manufacture, use, or sale is prohibited under any applicable laws or regulations.
- The information contained herein is presented only as guidance for Product use. No responsibility is assumed by TOSHIBA for any infringement of patents or any other intellectual property rights of third parties that may result from the use of Product. No license to any intellectual property right is granted by this document, whether express or implied, by estoppel or otherwise.
- **ABSENT A WRITTEN SIGNED AGREEMENT, EXCEPT AS PROVIDED IN THE RELEVANT TERMS AND CONDITIONS OF SALE FOR PRODUCT, AND TO THE MAXIMUM EXTENT ALLOWABLE BY LAW, TOSHIBA (1) ASSUMES NO LIABILITY WHATSOEVER, INCLUDING WITHOUT LIMITATION, INDIRECT, CONSEQUENTIAL, SPECIAL, OR INCIDENTAL DAMAGES OR LOSS, INCLUDING WITHOUT LIMITATION, LOSS OF PROFITS, LOSS OF OPPORTUNITIES, BUSINESS INTERRUPTION AND LOSS OF DATA, AND (2) DISCLAIMS ANY AND ALL EXPRESS OR IMPLIED WARRANTIES AND CONDITIONS RELATED TO SALE, USE OF PRODUCT, OR INFORMATION, INCLUDING WARRANTIES OR CONDITIONS OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, ACCURACY OF INFORMATION, OR NONINFRINGEMENT.**
- Do not use or otherwise make available Product or related software or technology for any military purposes, including without limitation, for the design, development, use, stockpiling or manufacturing of nuclear, chemical, or biological weapons or missile technology products (mass destruction weapons). Product and related software and technology may be controlled under the applicable export laws and regulations including, without limitation, the Japanese Foreign Exchange and Foreign Trade Law and the U.S. Export Administration Regulations. Export and re-export of Product or related software or technology are strictly prohibited except in compliance with all applicable export laws and regulations.
- Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. Please use Product in compliance with all applicable laws and regulations that regulate the inclusion or use of controlled substances, including without limitation, the EU RoHS Directive. **TOSHIBA ASSUMES NO LIABILITY FOR DAMAGES OR LOSSES OCCURRING AS A RESULT OF NONCOMPLIANCE WITH APPLICABLE LAWS AND REGULATIONS.**

# Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Toshiba:](#)

[TCR3UG19A,LF](#)